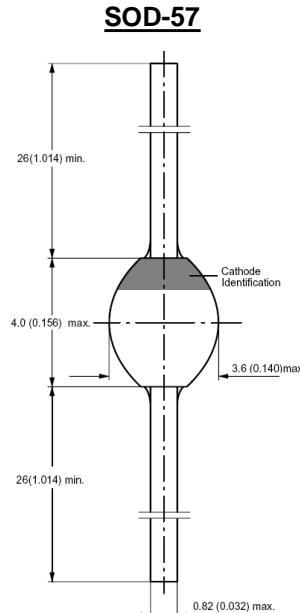


FEATURE

Very low switching losses
 Glass passivated
 Low reverse current
 High reverse voltage
 Hermetically sealed package

MECHANICAL DATA

Case: SOD-57 sintered glass case
 Terminal: Plated axial leads solderable per
 MIL-STD 202E, method 208C
 Polarity: color band denotes cathode end
 Mounting position: any



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half-wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated)

	SYMBOL	SF1600	units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	1600	V
Maximum RMS Voltage	V_{RMS}	1120	V
Maximum DC blocking Voltage	V_{DC}	1600	V
Minimum Reverse Breakdown Voltage $IR = 100\mu A$	$V_{(BR)R}$	1650	V
Average Forward Rectified Current half-sinewave, $Rth(ja)=45K/W$, $Ta=25^\circ C$	I_{FAV}	1.0	A
Peak Forward Surge Current at $t_p=10ms$, half sinewave	I_{FSM}	30	A
Maximum Forward Voltage at 1.0A	V_F	3.4	V
Non-repetitive peak reverse avalanche energy at $I_{BR(R)}=0.4A$	E_R	10	mJ
Maximum DC Reverse Current at rated DC blocking voltage $Ta = 25^\circ C$ $Ta = 125^\circ C$	I_R	5.0 50.0	μA
Maximum Reverse Recovery Time (Note 1)	T_{rr}	75	nS
Typical Thermal Resistance (Note 2)	$Rth(ja)$	45	K/W
Storage and Operating Junction Temperature	T_{stg}, T_j	-55 to +175	°C

Note:

1. Reverse Recovery Condition If $=0.5A$, $Ir =1.0A$, $Irr =0.25A$
2. Lead length $l =10mm$, $T_L = \text{constant}$

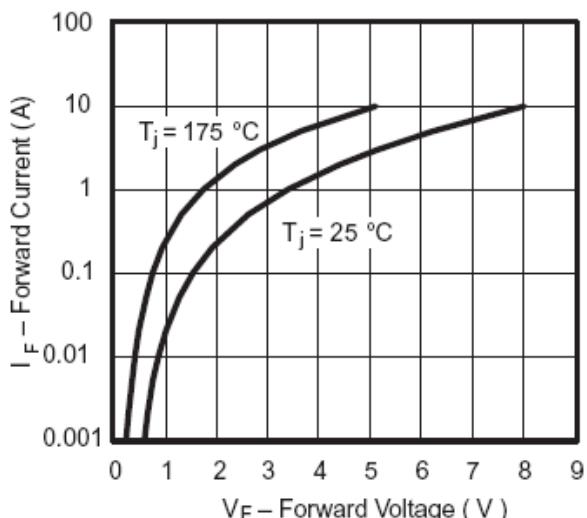


Figure 1. Max. Forward Current vs. Forward Voltage

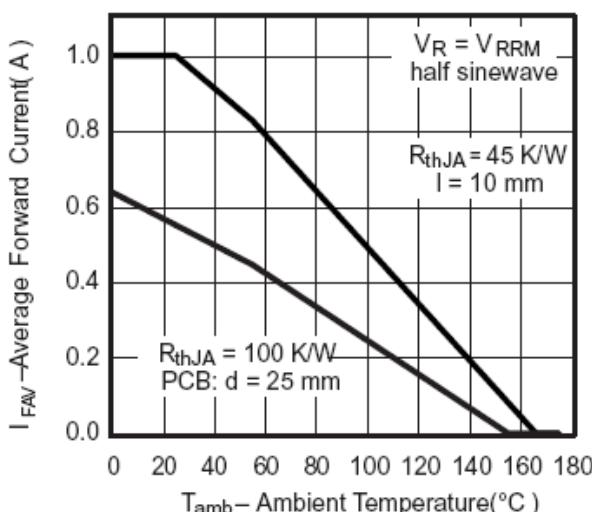


Figure 2. Max. Average Forward Current vs. Ambient Temperature

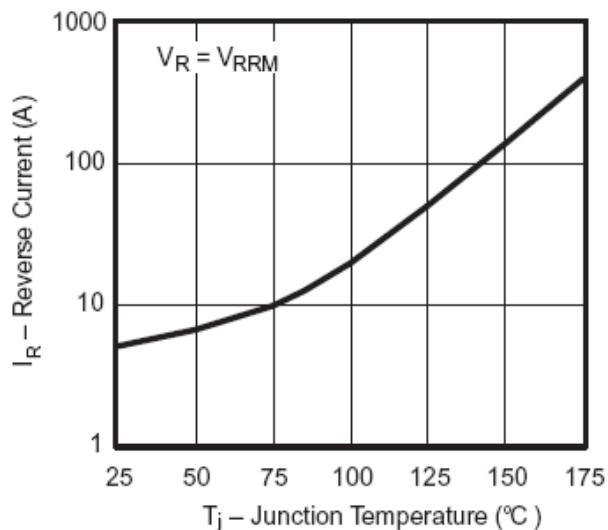


Figure 3. Reverse Current vs. Junction Temperature

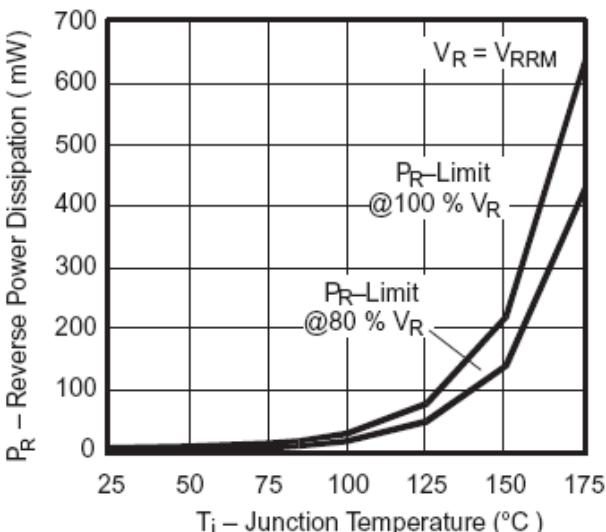


Figure 4. Max. Reverse Power Dissipation vs. Junction Temperature

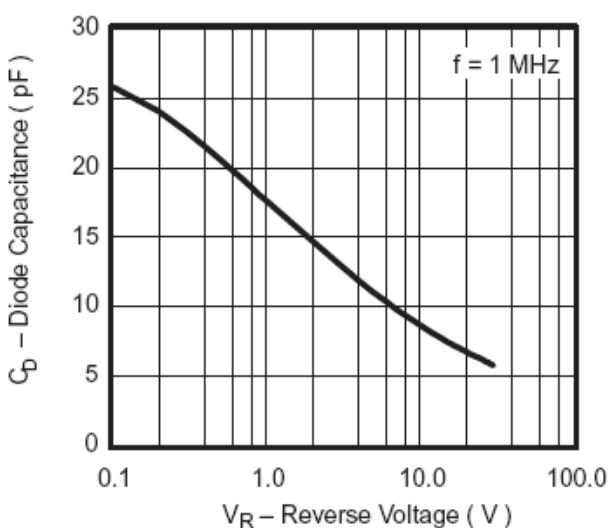


Figure 5. Diode Capacitance vs. Reverse Voltage